



<u>Application Form</u> REU SITE: Security Printing and Anti-Counterfeiting Technology

Application must be submitted by **5:00 p.m. (MST) March 18th, 2016. NOTE: Late or incomplete submissions may not be accepted**.

Name						
Mr./Ms.	Last	First	Middle	Initial		
Local Address				Phone		
	Street	City	State	Zip		
Permanent Address _						
	Street	City	State	Zip		
E-mail address						
Status at the present t	ime: Freshman_	Soph	omore	Junior	Senior	
Undergraduate GPA:			Major/I	Minor:		
Degree:			Expecte	ed Graduation Date	:	
Campus preference* * Campus where you						all preferences.
Name of <u>Faculty Mer</u>	mber providing rec	commendation (a	ttach letter with a	application):		
University:		D	ept.:	P	hone:	
Faculty Member E-m	ail address:					
In order to determine that all persons are af categories below. Co	forded an equal of	portunity for con	nsideration, REU			
Male	Female]	Minority: No	_Yes (I	f Yes, check one) H	Iispanic Ameri	can Indian
African Am	erican Asia	an Othe	er (Specify)			
Application Cheo (required docum	ents) ✓ Reco ✓ Curre		er (at least 1 requ ripts		search and the REU	Site focus
How did you hear ab	out this NSF REU	Program?				
Student Initials	Dat	e		•	pplication Subn Save application as Email or mail appl	s pdf or print.
D	irect Inquiries to:	South Dake Departmen 501 E. St. J	t of Materials an Ioseph Street; Ra	ant Professor ees & Technology d Metallurgical En pid City, SD 57701	supporting docume	ents to Dr. Crawford